

MIC5201

150 mA Low Dropout Regulator

Features

- AEC-Q100 for Fixed Option
- High Output Voltage Accuracy
- Variety of Output Voltages
- Ensured 150 mA Output
- · Low Quiescent Current
- · Low Dropout Voltage
- Extremely Tight Load and Line Regulation
- · Very Low Temperature Coefficient
- · Current and Thermal Limiting
- · Reversed-Battery Protection
- · Load-Dump Protection (Fixed Voltage Versions)
- · Zero Off-Mode Current
- Logic-Controlled Electronic Enable
- Available in SOIC-8 and SOT-223 Packages

Applications

- Cellular Telephones
- · Laptop, Notebook, and Palmtop Computers
- Battery Powered Equipment
- PCMCIA V_{CC} and V_{PP} Regulation/Switching
- Barcode Scanners
- SMPS Post-Regulator and DC/DC Modules
- High-Efficiency Linear Power Supplies

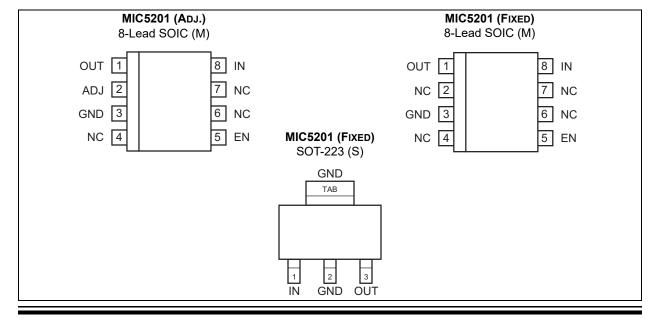
Package Types

General Description

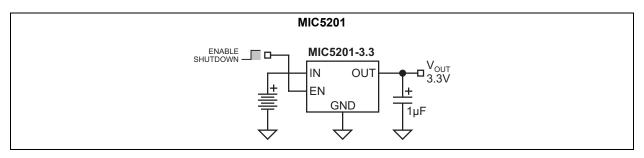
The MIC5201 is an efficient linear voltage regulator with very low dropout voltage (typically 17 mV at light loads and 200 mV at 100 mA), and very low ground current (1 mA at 100 mA output), offering better than 1% initial accuracy with a logic compatible on-off switching input.

Designed especially for hand-held battery powered devices, the MIC5201 can be switched by a CMOS enable signal. This enable control may be connected directly to $V_{\rm IN}$ if unneeded. When disabled, power consumption drops nearly to zero. The ground current of the MIC5201 increases only slightly in dropout, further prolonging battery life. Key MIC5201 features include current limiting, overtemperature shutdown, and protection against reversed battery.

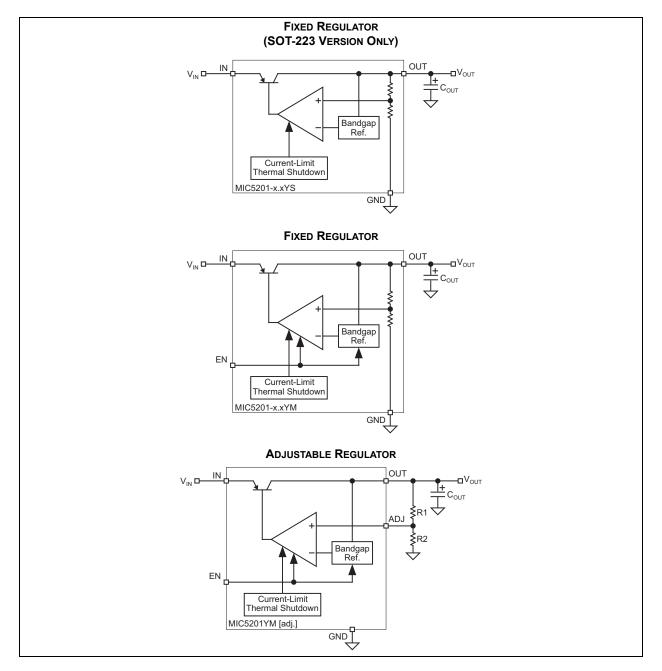
The MIC5201 is available in several fixed voltages and accuracy configurations. It features the same pinout as the LT1121 with better performance. Other options are available; contact Microchip for details.



Typical Application Circuit



Functional Diagrams



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Supply Input Voltage (V _{IN}) Fixed	
Supply Input Voltage (VIN) Adjustable	
Enable Input Voltage (V _{FN}) Fixed	
Enable Input Voltage (V _{EN}) Adjustable	
Power Dissipation (Note 1)	

Operating Ratings ‡

Supply Input Voltage (V _{IN}) Fixed	+2.5V to +26V
Supply Input Voltage (V _{IN}) Adjustable	
Enable Input Voltage (V _{EN})	0V to V _{IN}

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

‡ Notice: The device is not guaranteed to function outside its operating ratings.

Note 1: The maximum allowable power dissipation is a function of the maximum junction temperature, $T_{J(MAX)}$, the junction-to-ambient thermal resistance, θ_{JA} , and the ambient temperature, T_A . The maximum allowable power dissipation at any ambient temperature is calculated using: $P_{(MAX)} = (T_{J(MAX)} - T_A) \div \theta_{JA}$. Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator will go into thermal shutdown.

ELECTRICAL CHARACTERISTICS

Electrical Characteristics: $V_{IN} = V_{OUT} + 1V$; $I_L = 100 \ \mu\text{A}$; $C_L = 3.3 \ \mu\text{F}$; $V_{EN} \ge 2.0V$; $T_J = +25^{\circ}\text{C}$, **bold** values indicate $-40^{\circ}\text{C} \le T_J \le +85^{\circ}\text{C}$; unless noted. (Note 1)

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Output Voltage Accuracy	Vo	-2		2	%	Variation from specified V _{OUT}
Output Voltage Temperature Coefficient	ΔV _O /ΔT	_	40	150	ppm/°C	Note 2
Line Degulation Fixed			0.004	0.20	%	
Line Regulation, Fixed	$\Delta V_0 / V_0$		_	0.40		$V_{IN} = V_{OUT} + 1V$ to 26V
Line Regulation,			0.004	0.20	%	
Adjustable	$\Delta V_0 / V_0$		—	0.40	70	$V_{IN} = V_{OUT} + 1V$ to 16V
Load Pagulation		_	0.04	0.30	%	L = 0.1 mA to 150 mA Note 2
Load Regulation	$\Delta V_{O}/V_{O}$	_	—	0.40	70	I _L = 0.1 mA to 150 mA, Note 3
		_	17	_		I _L = 100 μA, Note 7
		_	130	_		I _L = 20 mA, Note 7
Dropout Voltage, Note 4	$V_{IN} - V_O$		180	_	mV	I _L = 50 mA, Note 7
		_	225	_		I _L = 100 mA, Note 7
		_	270	400		I _L = 150 mA
Quiescent Current	I _{GND}		0.01	_	μA	V _{ENABLE} ≤ 0.5V (shutdown), Note 7
	I _{GND}	_	130	_	μΑ	I _L = 100 μA, Note 7
		_	270	400		I _L = 20 mA
Ground Pin Current		_	500	—		I _L = 50 mA, Note 7
		_	1000	2000		I _L = 100 mA
		_	3000	_		I _L = 150 mA, Note 7
Ripple Rejection	PSRR	_	75	—	dB	f = 100 Hz, I _L = 1 mA, Note 7
Ground Pin Current at Dropout	I _{GDNDO}	_	270	330	μA	V_{IN} = 0.5V less than specified V _{OUT} , I _L = 100 µA, Note 5
Current Limit	I _{LIMIT}	_	280	500	mA	V _{OUT} = 0V
Thermal Regulation	$\Delta V_O / \Delta P_D$	_	0.05	_	%/W	Note 6
Output Noise	e _n	_	100	_	μV	Note 7
Enable Input						
Input Voltage Level	V _{IL}		_	0.5	V	Logic low (off)
Input Voltage Level	V _{IH}	2.0	—	_	V	Logic high (on)
Enable Input Current	۱ _{IL}		0.01	1	μA	V _{IL} ≤ 0.5V
Enable Input Current	I _{IH}		15	70	μA	V _{IH} ≥ 2.0V

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Characteristics: $V_{IN} = V_{OUT} + 1V$; $I_L = 100 \ \mu$ A; $C_L = 3.3 \ \mu$ F; $V_{EN} \ge 2.0V$; $T_J = +25^{\circ}$ C, **bold** values indicate -40° C $\le T_J \le +85^{\circ}$ C; unless noted. (Note 1)

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions		
Reference (MIC5201 Adjustable Version Only)								
Reference Voltage	V	1.223	1.242	1.255	· v —			
	V _{REF}	1.217	_	1.267		—		
Reference Voltage Temperature Coefficient	$\Delta V_{REF} / \Delta T$	_	20	_	ppm/°C	Note 7		

Note 1: Specification for packaged product only. Devices are ESD sensitive. Handling precautions recommended.

- **2:** Output voltage temperature coefficient is defined as the worst-case voltage change divided by the total temperature range.
- **3:** Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 0.1 mA to 150 mA. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
- 4: Dropout Voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value measured at 1V differential.
- **5:** Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.
- 6: Thermal regulation is defined as the change in output voltage at a time "t" after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for a 150 mA load pulse at V_{IN} = 26V for fixed and V_{IN} = 16V for adjustable at t = 10 ms.
- 7: Design guidance only. Not production tested.

TEMPERATURE SPECIFICATIONS (Note 1)

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions	
Temperature Ranges							
Junction Temperature Range	Τ _J	-40		+85	°C	—	
Lead Temperature	—	—		+260	°C	Soldering, 5 sec.	
Package Thermal Resistance							
	θ _{JC}	—	15	_		See Thermal	
Thermal Resistance SOT-223	θ_{JA}	-	62	—	°C/W	Considerations Layout for more information.	
Thermal Resistance 8-Lead SOIC	θ _{JA}	_	160	_	°C/W	See Thermal Considerations Layout for more information.	

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A, T_J, θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +85°C rating. Sustained junction temperatures above +85°C can impact the device reliability.

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

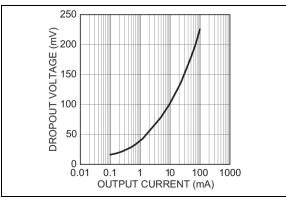


FIGURE 2-1: Dropout Voltage vs. Output Current.

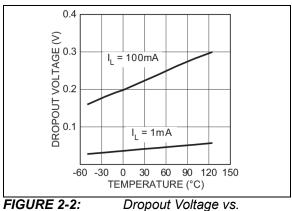
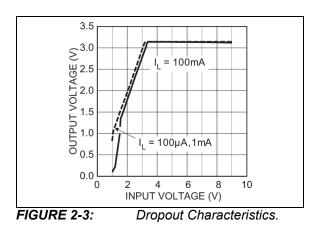


FIGURE 2-2: I Temperature.



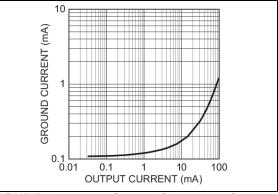


FIGURE 2-4: Ground Current vs. Output Current.

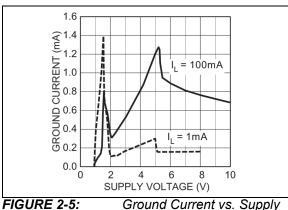
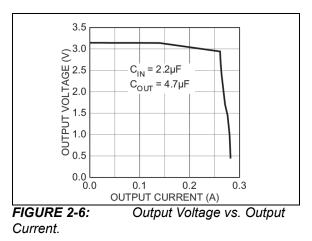


FIGURE 2-5: Ground Current vs. Supply Voltage.



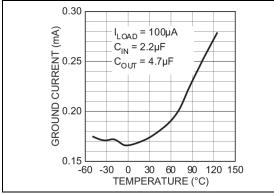
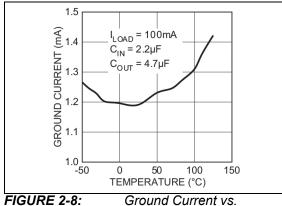
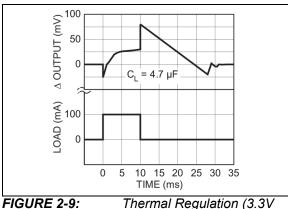


FIGURE 2-7: Ground Current vs. Temperature.







Version).

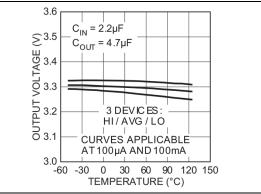


FIGURE 2-10: Output Voltage vs. Temperature (3.3V Version).

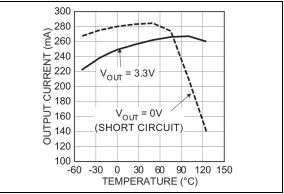


FIGURE 2-11: Output Current vs. Temperature.

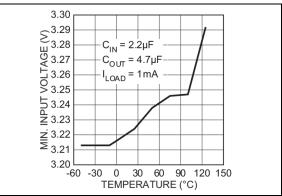


FIGURE 2-12: Minimum Input Voltage vs. Temperature.

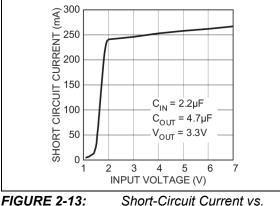


FIGURE 2-13: Input Voltage.

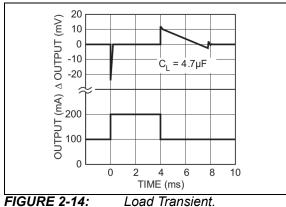


FIGURE 2-14:

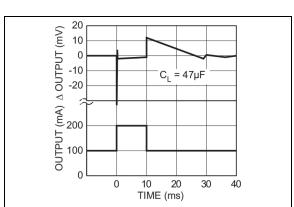


FIGURE 2-15: Load Transient.

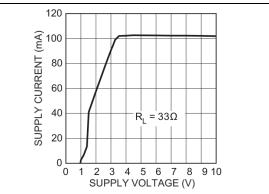


FIGURE 2-16: Supply Current vs. Supply Voltage (3.3V Version).

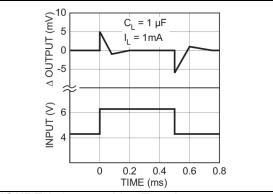


FIGURE 2-17:



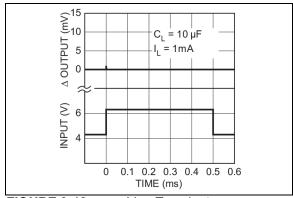


FIGURE 2-18: Line Transient.

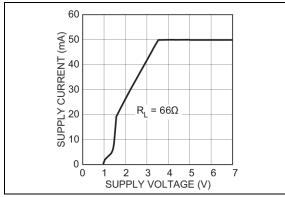
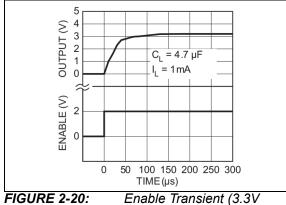
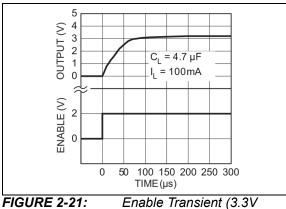


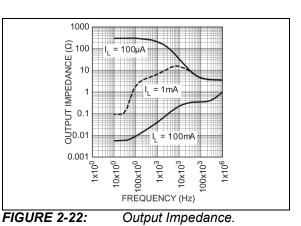
FIGURE 2-19: Supply Current vs. Supply Voltage (3.3V Version).



Version).



Version).



 $\begin{array}{c} 35 \\ 30 \\ 25 \\ 20 \\ 10 \\ 20 \\ 10 \\ 10 \\ 5 \\ -5 \\ -60 \\ -30 \\ 0 \\ -5 \\ -60 \\ -30 \\ 0 \\ 30 \\ 60 \\ 90 \\ 120 \\ 150 \\$

FIGURE 2-23: Enable Current Threshold vs. Temperature.

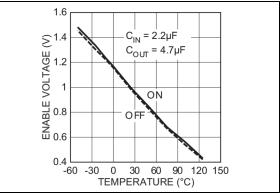


FIGURE 2-24: Enable Voltage Threshold vs. Temperature.

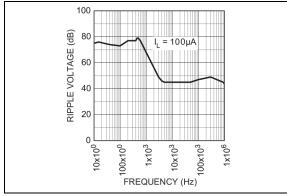
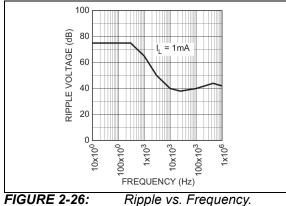


FIGURE 2-25: Ripple vs. Frequency.



Ripple vs. Frequency.

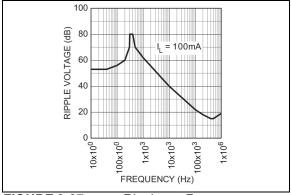


FIGURE 2-27:

Ripple vs. Frequency.

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

TABLE 0-1.							
Pin Number SOT-223	Pin Number SOIC-8 (Adj.)	Pin Number SOIC-8 (Fixed)	Pin Name	Description			
3	1	1	OUT	Regulated output.			
—	2	_	ADJ	Feedback input. Adjustable version only.			
_	4, 6, 7	2, 4, 6, 7	NC	Not internally connected. Connect to ground plane for lowest thermal resistance.			
2	3	3	GND	Ground.			
_	5	5	EN	Enable (input): High = enable. Low or open = off/disable.			
1	8	8	V _{IN}	Unregulated supply input.			

TABLE 3-1: PIN FUNCTION TABLE

4.0 APPLICATIONS INFORMATION

Figure 4-1 shows a basic fixed-voltage application with the unused enable input connected to V_{IN} .

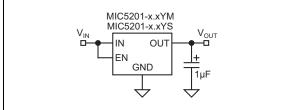


FIGURE 4-1: Fixed Application.

Adjustable regulators require two resistors to set the output voltage. See Figure 4-2.

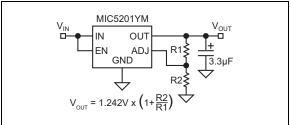


FIGURE 4-2:

Adjustable Application.

Resistor values are not critical because ADJ (adjust) has a high impedance, but for best results use resistors of 470 k Ω or less.

4.1 Output Capacitors

A 1 μ F capacitor is recommended between the MIC5201 output and ground to prevent oscillations due to instability. Larger values serve to improve the regulator's transient response. Most types of tantalum or aluminum electrolytics will be adequate; film types will work, but are costly and therefore not recommended. Many aluminum electrolytics have electrolytes that freeze at about -30° C, so solid tantalums are recommended for operation below -25° C. The important parameters of the capacitor are an effective series resistance of about 5 Ω or less and a resonant frequency above 500 kHz. The value of this capacitor may be increased without limit.

At lower values of output current, less output capacitance is required for output stability. The capacitor can be reduced to 0.47 μ F for current below 10 mA or 0.33 μ F for currents below 1 mA.

4.2 Input Capacitors

A 1 μ F capacitor should be placed from the MIC5201 input to ground if there is more than 10 inches of wire between the input and the AC filter capacitor or if a battery is used as the input.

4.3 Noise Reduction Capacitors

On adjustable devices, a capacitor from ADJ to GND will decrease high-frequency noise on the output. See Figure 4-3.

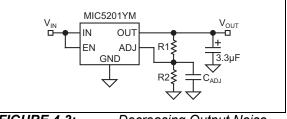


FIGURE 4-3: Decreasing Output Noise.

4.4 Minimum Load

The MIC5201 will remain stable and in regulation with no load unlike many other voltage regulators. This is especially important in CMOS RAM keep-alive applications.

4.5 Dual-Supply Systems

When used in dual supply systems where the regulator load is returned to a negative supply, the output voltage must be diode clamped to ground.

4.6 Thermal Considerations Layout

The MIC5201-x.xYM (8-pin surface mount package) has the following thermal characteristics when mounted on a single layer copper-clad printed circuit board.

TABLE 4-1: THERMAL CHARACTERISTICS

PCB Dielectric	θ _{JA}
FR4	160°C/W
Ceramic	120°C/W

Multilayer boards having a ground plane, wide traces near the pads, and large supply bus lines provide better thermal conductivity.

The "worst case" value of 160°C/W assumes no ground plane, minimum trace widths, and a FR4 material board.

4.7 Nominal Power Dissipation and Die Temperature

The MIC5201-x.xYM at a +25°C ambient temperature will operate reliably at up to 625 mW power dissipation when mounted in the "worst case" manner described above. At an ambient temperature of +55°C, the device may safely dissipate 440 mW. These power levels are equivalent to a die temperature of +85°C, the recommended maximum temperature for non-military grade silicon integrated circuits.

For MIC5201-x.xYS (SOT-223 package) heat sink characteristics, please refer to Application Hint 17, P.C. Board Heat Sinking.

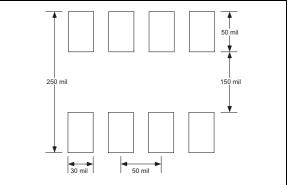
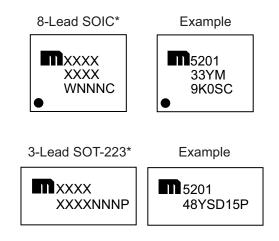


FIGURE 4-4: Minimum Recommended SOIC-8 PCB Pads Size.

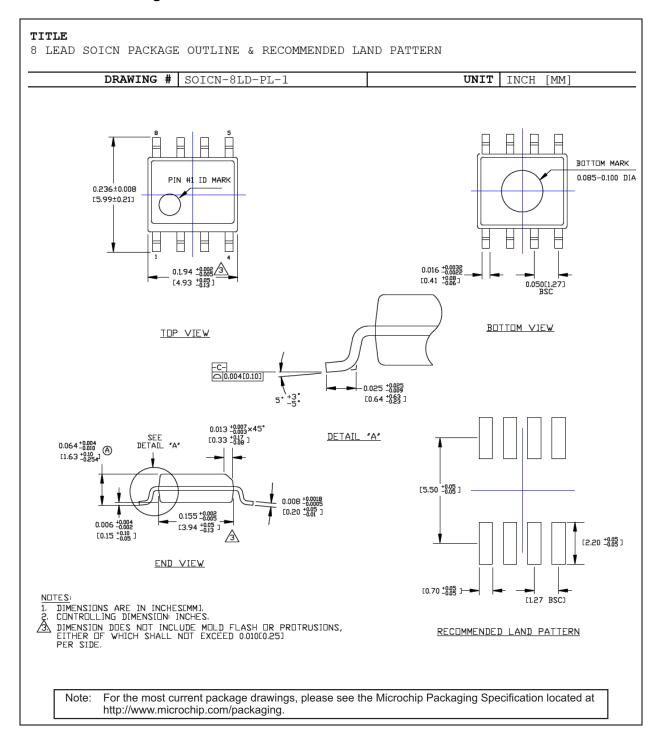
5.0 PACKAGING INFORMATION

5.1 Package Marking Information

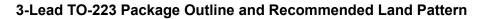


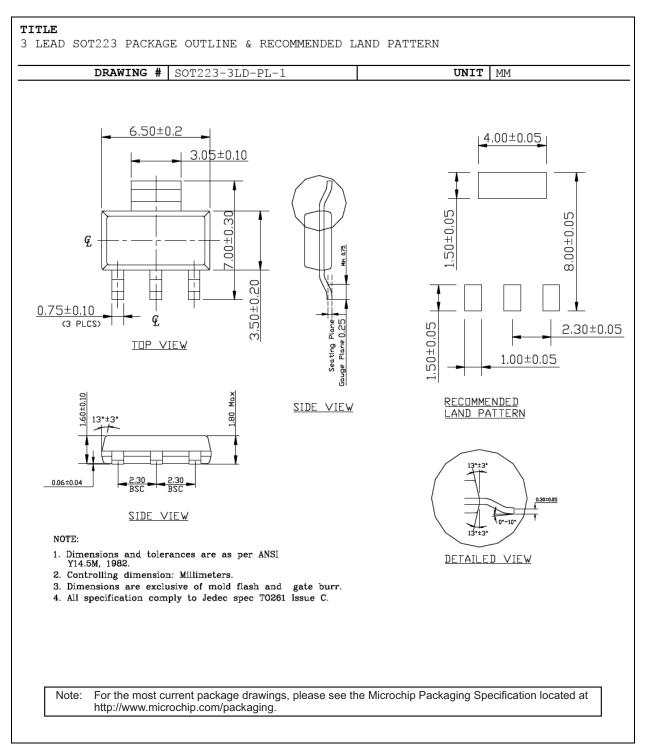
Legend:	Y YY WW NNN @3 *	Product code or customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC [®] designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package. Pin one index is identified by a dot, delta up, or delta down (triangle
b c ti	be carried characters he corpor	nt the full Microchip part number cannot be marked on one line, it will l over to the next line, thus limiting the number of available for customer-specific information. Package may or may not include ate logo. () and/or Overbar (¯) symbol may not be to scale.

Note: If the full seven-character YYWWNNN code cannot fit on the package, the following truncated codes are used based on the available marking space:
6 Characters = YWWNNN; 5 Characters = WWNNN; 4 Characters = WNNN; 3 Characters = NNN; 2 Characters = NN; 1 Character = N



8-Lead SOIC Package Outline and Recommended Land Pattern





APPENDIX A: REVISION HISTORY

Revision A (February 2017)

- Converted Micrel document MIC5201 to Microchip data sheet DS20005718A.
- Minor text changes throughout.
- Removed all reference to discontinued leaded parts.
- Added θ_{JA} value for SOT-223 package in Temperature Specifications (Note 1) section.

Revision B (July 2020)

- Updated Features section.
- Updated Electrical Characteristics table.
- Updated Product Identification System section.

Revision C (April 2021)

- Removed redundant delta symbol from three Regulation entries in Electrical Characteristics table.
- Updated Ripple Rejection conditions in Electrical Characteristics table.
- Corrected equation in Figure 4-2.

Revision D (February 2022)

• Updated the Package Marking Information drawing with the most current information. NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NoX.	<u>x x x -xx xxx</u>	Examples:
Device Volta		a) MIC5201YM: 150 mA Low Dropout Regulat Adjustable Voltage, 8-Lead SOIC, -40°C to +85°C Junction Temperature Range, 95/Tube
Voltage:	(blank) = Adjustable (M package only) $3.0 = 3.0 \lor$ $3.3 = 3.3 \lor$ $4.8 = 4.8 \lor$ (S package only)	b) MIC5201-3.0YM-TR: 150 mA Low Dropout Regulat 3.0V Voltage, 8-Lead SOIC, -40°C to +85°C Junction Temperature Range, 2,500/Reel
Junction Temperature Range:	5.0 = 5.0V Y = -40°C to +85°C	c) MIC5201-3.3YM: 150 mA Low Dropout Regulat 3.3V Voltage, 8-Lead SOIC, -40°C to +85°C Junction Temperature Range, 95/Tube
Package:	M = 8-Lead SOIC S = 3-Lead SOT-223 TR = 4,000/Reel (S Package, Automotive)	d) MIC5201-5.0YM-TR: 150 mA Low Dropout Regulat 5.0V Voltage, 8-Lead SOIC, -40°C to +85°C Junction Temperature Range, 2,500/Reel
Media Type:	(blank)= 78/Tube (S Package, Automotive) TR = 3,300/Reel (M Package, Automotive) (blank)= 100/Tube (M Package, Automotive) TR = 2,500/Reel (S Package, Commercial) (blank)= 78/Tube (S Package, Commercial) TR = 2,500/Reel (M Package, Commercial) TR = 2,500/Reel (M Package, Commercial)	e) MIC5201-3.0YS: 150 mA Low Dropout Regulat 3.0V Voltage, 3-Lead SOT-22 -40°C to +85°C Junction Temperature Range, 78/Tube
Qualification:	 (blank) = 95/Tube (M Package, Commercial) (blank) = Standard Qualification VAO = AEC-Q100 Automotive Qualification Vxx = AEC-Q100 Automotive Qualification, custom 	f) MIC5201-3.3YS-TR: 150 mA Low Dropout Regulat 3.3V Voltage, 3-Lead SOT-22 -40°C to +85°C Junction Temperature Range, 2,500/Reel
	device, additional terms or conditions may apply	g) MIC5201-4.8YS: 150 mA Low Dropout Regulat 4.8V Voltage, 3-Lead SOT-22 -40°C to +85°C Junction Temperature Range, 78/Tube
		h) MIC5201-5.0YS-TR: 150 mA Low Dropout Regulat 5.0V Voltage, 3-Lead SOT-22 -40°C to +85°C Junction Temperature Range, 2,500/Reel
		 i) MIC5201-5.0YM-TRVAO:150 mA Low Dropout Regula 5.0V Voltage, 8-Lead SOIC, -40°C to +85°C Junction Temperature Range, 3,300/Reel
		 j) MIC5201-3.3YM-TRVAO:150 mA Low Dropout Regula 3.3V Voltage, 8-Lead SOIC, -40°C to +85°C Junction Temperature Range, 3,300/Reel
		 k) MIC5201-5.0YS-TRVAO:150 mA Low Dropout Regula 5.0V Voltage, 3-Lead SOT-22 -40°C to +85°C Junction Temperature Range, 4,000/Reel
		Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed or the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.

NOTES:

Note the following details of the code protection feature on Microchip products:

- · Microchip products meet the specifications contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is secure when used in the intended manner, within operating specifications, and under normal conditions.
- Microchip values and aggressively protects its intellectual property rights. Attempts to breach the code protection features of Microchip product is strictly prohibited and may violate the Digital Millennium Copyright Act.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of its code. Code protection does not
 mean that we are guaranteeing the product is "unbreakable". Code protection is constantly evolving. Microchip is committed to
 continuously improving the code protection features of our products.

This publication and the information herein may be used only with Microchip products, including to design, test, and integrate Microchip products with your application. Use of this information in any other manner violates these terms. Information regarding device applications is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. Contact your local Microchip sales office for additional support or, obtain additional support at https:// www.microchip.com/en-us/support/design-help/client-supportservices.

THIS INFORMATION IS PROVIDED BY MICROCHIP "AS IS". MICROCHIP MAKES NO REPRESENTATIONS OR WAR-RANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION INCLUDING BUT NOT LIMITED TO ANY IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY, AND FITNESS FOR A PARTICULAR PURPOSE, OR WARRANTIES RELATED TO ITS CONDITION, QUALITY, OR PERFORMANCE.

IN NO EVENT WILL MICROCHIP BE LIABLE FOR ANY INDI-RECT, SPECIAL, PUNITIVE, INCIDENTAL, OR CONSE-QUENTIAL LOSS, DAMAGE, COST, OR EXPENSE OF ANY KIND WHATSOEVER RELATED TO THE INFORMATION OR ITS USE, HOWEVER CAUSED, EVEN IF MICROCHIP HAS BEEN ADVISED OF THE POSSIBILITY OR THE DAMAGES ARE FORESEEABLE. TO THE FULLEST EXTENT ALLOWED BY LAW, MICROCHIP'S TOTAL LIABILITY ON ALL CLAIMS IN ANY WAY RELATED TO THE INFORMATION OR ITS USE WILL NOT EXCEED THE AMOUNT OF FEES, IF ANY, THAT YOU HAVE PAID DIRECTLY TO MICROCHIP FOR THE INFORMATION.

Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Trademarks

The Microchip name and logo, the Microchip logo, Adaptec, AnyRate, AVR, AVR logo, AVR Freaks, BesTime, BitCloud, CryptoMemory, CryptoRF, dsPIC, flexPWR, HELDO, IGLOO, JukeBlox, KeeLoq, Kleer, LANCheck, LinkMD, maXStylus, maXTouch, MediaLB, megaAVR, Microsemi, Microsemi logo, MOST, MOST logo, MPLAB, OptoLyzer, PIC, picoPower, PICSTART, PIC32 logo, PolarFire, Prochip Designer, QTouch, SAM-BA, SenGenuity, SpyNIC, SST, SST Logo, SuperFlash, Symmetricom, SyncServer, Tachyon, TimeSource, tinyAVR, UNI/O, Vectron, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

AgileSwitch, APT, ClockWorks, The Embedded Control Solutions Company, EtherSynch, Flashtec, Hyper Speed Control, HyperLight Load, IntelliMOS, Libero, motorBench, mTouch, Powermite 3, Precision Edge, ProASIC, ProASIC Plus, ProASIC Plus logo, Quiet-Wire, SmartFusion, SyncWorld, Temux, TimeCesium, TimeHub, TimePictra, TimeProvider, TrueTime, WinPath, and ZL are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, Augmented Switching, BlueSky, BodyCom, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, Espresso T1S, EtherGREEN, GridTime, IdealBridge, In-Circuit Serial Programming, ICSP, INICnet, Intelligent Paralleling, Inter-Chip Connectivity, JitterBlocker, Knob-on-Display, maxCrypto, maxView, memBrain, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, NVM Express, NVMe, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, RTAX, RTG4, SAM-ICE, Serial Quad I/O, simpleMAP, SimpliPHY, SmartBuffer, SmartHLS, SMART-I.S., storClad, SQI, SuperSwitcher, SuperSwitcher II, Switchtec, SynchroPHY, Total Endurance, TSHARC, USBCheck, VariSense, VectorBlox, VeriPHY, ViewSpan, WiperLock, XpressConnect, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

The Adaptec logo, Frequency on Demand, Silicon Storage Technology, Symmcom, and Trusted Time are registered trademarks of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

 $\ensuremath{\textcircled{\sc 0}}$ 2017 - 2022, Microchip Technology Incorporated and its subsidiaries.

All Rights Reserved.

ISBN: 978-1-5224-9872-8

For information regarding Microchip's Quality Management Systems, please visit www.microchip.com/quality.



Worldwide Sales and Service

AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Novi, MI Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453 Tel: 317-536-2380

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608 Tel: 951-273-7800

Raleigh, NC Tel: 919-844-7510

New York, NY Tel: 631-435-6000

San Jose, CA Tel: 408-735-9110 Tel: 408-436-4270

Canada - Toronto Tel: 905-695-1980 Fax: 905-695-2078

ASIA/PACIFIC

Australia - Sydney Tel: 61-2-9868-6733

China - Beijing Tel: 86-10-8569-7000 China - Chengdu

Tel: 86-28-8665-5511 China - Chongqing Tel: 86-23-8980-9588

China - Dongguan Tel: 86-769-8702-9880

China - Guangzhou Tel: 86-20-8755-8029

China - Hangzhou Tel: 86-571-8792-8115

China - Hong Kong SAR Tel: 852-2943-5100

China - Nanjing Tel: 86-25-8473-2460

China - Qingdao Tel: 86-532-8502-7355

China - Shanghai Tel: 86-21-3326-8000

China - Shenyang Tel: 86-24-2334-2829

China - Shenzhen Tel: 86-755-8864-2200

China - Suzhou Tel: 86-186-6233-1526

China - Wuhan Tel: 86-27-5980-5300

China - Xian Tel: 86-29-8833-7252

China - Xiamen Tel: 86-592-2388138 China - Zhuhai

Tel: 86-756-3210040

ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444

India - New Delhi Tel: 91-11-4160-8631 India - Pune

Tel: 91-20-4121-0141

Japan - Osaka Tel: 81-6-6152-7160

Japan - Tokyo Tel: 81-3-6880- 3770

Korea - Daegu Tel: 82-53-744-4301

Korea - Seoul Tel: 82-2-554-7200

Malaysia - Kuala Lumpur Tel: 60-3-7651-7906

Malaysia - Penang Tel: 60-4-227-8870

Philippines - Manila Tel: 63-2-634-9065

Singapore Tel: 65-6334-8870

Taiwan - Hsin Chu

Tel: 886-3-577-8366 Taiwan - Kaohsiung Tel: 886-7-213-7830

Taiwan - Taipei Tel: 886-2-2508-8600

Thailand - Bangkok Tel: 66-2-694-1351

Vietnam - Ho Chi Minh Tel: 84-28-5448-2100

Tel: 39-049-7625286

EUROPE

Austria - Wels

Tel: 43-7242-2244-39

Tel: 45-4485-5910

Fax: 45-4485-2829

Tel: 358-9-4520-820

Tel: 33-1-69-53-63-20

Fax: 33-1-69-30-90-79

Germany - Garching

Tel: 49-2129-3766400

Germany - Heilbronn

Germany - Karlsruhe

Tel: 49-7131-72400

Tel: 49-721-625370

Germany - Munich

Tel: 49-89-627-144-0

Fax: 49-89-627-144-44

Germany - Rosenheim

Tel: 49-8031-354-560

Israel - Ra'anana

Italy - Milan

Italy - Padova

Tel: 972-9-744-7705

Tel: 39-0331-742611

Fax: 39-0331-466781

Tel: 49-8931-9700

Germany - Haan

Finland - Espoo

France - Paris

Fax: 43-7242-2244-393

Denmark - Copenhagen

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

Norway - Trondheim Tel: 47-7288-4388

Poland - Warsaw Tel: 48-22-3325737

Romania - Bucharest Tel: 40-21-407-87-50

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Gothenberg Tel: 46-31-704-60-40

Sweden - Stockholm Tel: 46-8-5090-4654

UK - Wokingham Tel: 44-118-921-5800 Fax: 44-118-921-5820

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Microchip:

MIC5201-3.0YS MIC5201-5.0YS MIC5201-3.3YS MIC5201-5.0YM MIC5201-3.3YS TR MIC5201-3.3YM MIC5201YM MIC5201-4.8YS MIC5201-3.0YM MIC5201-4.8YS TR MIC5201-3.0YMM TR MIC5201YM TR MIC5201-3.0YS TR MIC5201-4.8YM TR MIC5201-3.3YM TR MIC5201-5.0YS TR MIC5201-3.0YM TR MIC5201-3.0YMM MIC5201-5.0YM TR MIC5201-4.8YM MIC5201-3.0YM-TR MIC5201-3.3YS-TR MIC5201YM-TR MIC5201-5.0YM-TR MIC5201-5.0YS-TR MIC5201-4.8YS-TR MIC5201-3.0YMM-TR MIC5201-3.0YS-TR MIC5201-4.8YM-TR MIC5201-3.3YM-TR